Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

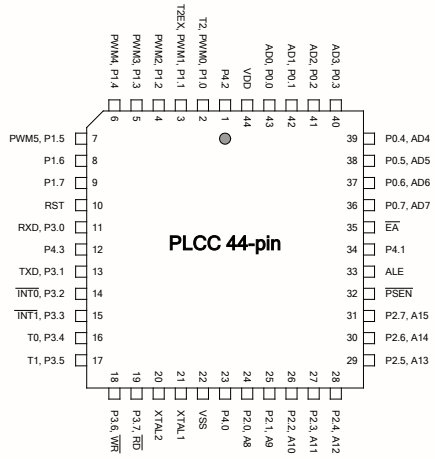
"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

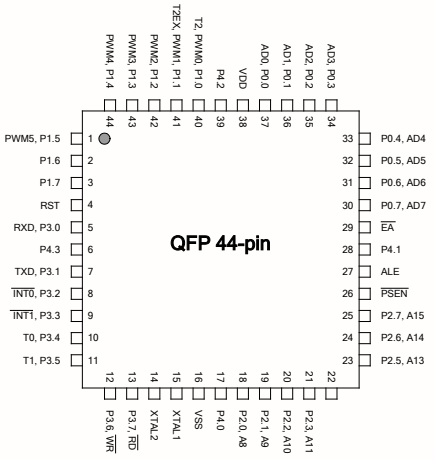
Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	8051
Core Size	8-Bit
Speed	40MHz
Connectivity	EBI/EMI, UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	36
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1.25K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	44-BQFP
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/nuvoton-technology-corporation-america/w79e632a40fl

DEVICE	OPERATING FREQUENCY	OPERATING VOLTAGE	PACKAGE
			LEAD FREE(ROHS)
W79E632A40PL/FL	Up to 40.0MHz	5.0V ~ 5.5V	PLCC44, QFP44
	Up to 36.8MHz	4.5V ~ 5.5V	
W79L632A25PL/FL	Up to 20.0MHz	3.3V ~ 5.5V	PLCC44, QFP44
	Up to 12.0MHz	3.0V ~ 5.5V	

3. PIN CONFIGURATIONS





6. MEMORY ORGANIZATION

The W79E(L)632 separates the memory into two separate sections, the Program Memory and the Data Memory. The Program Memory is used to store the instruction op-codes, while the Data Memory is used to store data or for memory mapped devices.

Program Memory

The Program Memory on the standard 8052 can only be addressed to 64 Kbytes long. By invoking the banking methodology, W79E(L)632 can extend to two 64KB flash EPROM banks, APFlash0 and APFlash1. There are on-chip ROM banks which can be used similarly to that of the 8052. All instructions are fetched for execution from this memory area. The MOVC instruction can also access this memory region. There is an auxiliary 4KB Flash EPROM bank (LDFlash) resided user loader program for In-System Programming (ISP). Both APFlashs allow serial or parallel download according to user loader program in LDFlash.

Data Memory

The W79E(L)632 can access up to 64Kbytes of external Data Memory. This memory region is accessed by the MOVX instructions. Unlike the 8051 derivatives, the W79E(L)632 contains on-chip 1K bytes MOVX SRAM of Data Memory, which can only be accessed by MOVX instructions. These 1K bytes of SRAM are between address 0000H and 03FFH. Access to the on-chip MOVX SRAM is optional under software control. When enabled by software, any MOVX instruction that uses this area will go to the on-chip RAM. MOVX addresses greater than 03FFH automatically go to external memory through Port 0 and 2. When disabled, the 1KB memory area is transparent to the system memory map. Any MOVX directed to the space between 0000H and FFFFH goes to the expanded bus on Port 0 and 2. This is the default condition. In addition, the W79E(L)632 has the standard 256 bytes of on-chip Scratchpad RAM. This can be accessed either by direct addressing or by indirect addressing. There are also some Special Function Registers (SFRs), which can only be accessed by direct addressing. Since the Scratchpad RAM is only 256 bytes, it can be used only when data contents are small. In the event that larger data contents are present, two selections can be used. One is on-chip MOVX SRAM, the other is the external Data Memory. The on-chip MOVX SRAM can only be accessed by a MOVX instruction, the same as that for external Data Memory. However, the on-chip RAM has the fastest access times.

MD2–0: Stretch MOVX select bits: These three bits are used to select the stretch value for the MOVX instruction. Using a variable MOVX length enables the user to access slower external memory devices or peripherals without the need for external circuits. The $\overline{RD}$ or $\overline{WR}$ strobe will be stretched by the selected interval. When accessing the on-chip SRAM, the MOVX instruction is always in 2 machine cycles regardless of the stretch setting. By default, the stretch has value of 1. If the user needs faster accessing, then a stretch value of 0 should be selected.

MD2	MD1	MD0	Stretch value	MOVX duration
0	0	0	0	2 machine cycles
0	0	1	1	3 machine cycles *(Default)*
0	1	0	2	4 machine cycles
0	1	1	3	5 machine cycles
1	0	0	4	6 machine cycles
1	0	1	5	7 machine cycles
1	1	0	6	8 machine cycles
1	1	1	7	9 machine cycles

Port 1

Bit:	7	6	5	4	3	2	1	0
	P1.7	P1.6	P1.5	P1.4	P1.3	P1.2	P1.1	P1.0

Mnemonic: P1 Address: 90h

P1.7–0: General purpose I/O port. Most instructions will read the port pins in case of a port read access, however in case of read-modify-write instructions, the port latch is read. Some pins also have alternate input or output functions. This alternate functions are described below:

P1.0 : T2 External I/O for Timer/Counter 2
P1.1 : T2EX Timer/Counter 2 Capture/Reload Trigger

Port 4 Control Register A

Bit:	7	6	5	4	3	2	1	0
	P41M1	P41M0	P41C1	P41C0	P40M1	P40M0	P40C1	P40C0

Mnemonic: P4CONA Address: 92h

Port 4 Control Register B

Bit:	7	6	5	4	3	2	1	0
	P43M1	P43M0	P43C1	P43C0	P42M1	P42M0	P42C1	P42C0

Mnemonic: P4CONB Address: 93h

Software Reset

Set CHPCON = 0X83, timer and enter IDLE mode. CPU will reset and restart from APFlash after time out.

Port 2

Bit:	7	6	5	4	3	2	1	0
	P2.7	P2.6	P2.5	P2.4	P2.3	P2.2	P2.1	P2.0

Mnemonic: P2 Address: A0h

P2.7-0: Port 2 is a bi-directional I/O port with internal pull-ups. This port also provides the upper address bits for accesses to external memory.

Port 4 Chip-select Polarity

Bit:	7	6	5	4	3	2	1	0
	P43INV	P42INV	P42INV	P40INV	-	-	-	P0UP

Mnemonic: P4CSIN Address: A2h

P4xINV: The active polarity of P4.x when set it as chip-select signal. High = Active High. Low = Active Low.

P0UP: Enable Port 0 weak pull up.

Port 4

Bit:	7	6	5	4	3	2	1	0
	-	-	-	-	P4.3	P4.2	P4.1	P4.0

Mnemonic: P4 Address: A5h

P4.3-0: Port 4 is a bi-directional I/O port with internal pull-ups. Port 4 can not use bit-addressable instruction (SETB or CLR).

Interrupt Enable

Bit:	7	6	5	4	3	2	1	0
	EA	ES1	ET2	ES	ET1	EX1	ET0	EX0

Mnemonic: IE Address: A8h

EA: Global enable. Enable/disable all interrupts.
ET2: Enable Timer 2 interrupt.
ES: Enable Serial Port 0 interrupt.
ET1: Enable Timer 1 interrupt
EX1: Enable external interrupt 1
ET0: Enable Timer 0 interrupt
EX0: Enable external interrupt 0

Slave Address

Bit:	7	6	5	4	3	2	1	0

Mnemonic: SADDR Address: A9h

SADDR: The SADDR should be programmed to the given or broadcast address for serial port 0 to which the slave processor is designated.

ROM Banking Control

Bit:	7	6	5	4	3	2	1	0
	-	-	-	-	EN128K	DCP12	DCP11	DCP10

Mnemonic: ROMCON Address: ABh

EN128K: On-chip ROM banking enable. Set this bit to enable APFlash0 and APFlash1 by banking mechanism. The P1.x is selected to be the auxiliary highest address line A16.

DCP1x: A16 selection. By default, P1.7 is defined as A16.

A16	P1.0	P1.1	P1.2	P1.3	P1.4	P1.5	P1.6	P1.7
DCP12	0	0	0	0	1	1	1	1
DCP11	0	0	1	1	0	0	1	1
DCP10	0	1	0	1	0	1	0	1

ISP Address Low Byte

Bit:	7	6	5	4	3	2	1	0
	A7	A6	A5	A4	A3	A2	A1	A0

Mnemonic: SFRAL Address: ACh

Low byte destination address for In System Programming operation. SFRAH and SFRAL address a specific ROM byte for erasure, programming or read.

ISP Address High Byte

Bit:	7	6	5	4	3	2	1	0
	A15	A14	A13	A12	A11	A10	A9	A8

Mnemonic: SFRAH Address: ADh

High byte destination address for In System Programming operation. SFRAH and SFRAL address a specific ROM byte for erasure, programming or read.

P3.3	$\overline{INT1}$	External interrupt 1
P3.2	$\overline{INT0}$	External interrupt 0
P3.1	TxD	Serial port 0 output
P3.0	RxD	Serial port 0 input

Interrupt Priority

Bit:	7	6	5	4	3	2	1	0
	-	-	PT2	PS	PT1	PX1	PT0	PX0

Mnemonic: IP Address: B8h

IP.7: This bit is un-implemented and will read high.

PT2: This bit defines the Timer 2 interrupt priority. PT2 = 1 sets it to higher priority level.

PS: This bit defines the Serial port 0 interrupt priority. PS = 1 sets it to higher priority level.

PT1: This bit defines the Timer 1 interrupt priority. PT1 = 1 sets it to higher priority level.

PX1: This bit defines the External interrupt 1 priority. PX1 = 1 sets it to higher priority level.

PT0: This bit defines the Timer 0 interrupt priority. PT0 = 1 sets it to higher priority level.

PX0: This bit defines the External interrupt 0 priority. PX0 = 1 sets it to higher priority level.

Slave Address Mask Enable

Bit:	7	6	5	4	3	2	1	0

Mnemonic: SADEN Address: B9h

SADEN: This register enables the Automatic Address Recognition feature of the Serial port 0. When a bit in the SADEN is set to 1, the same bit location in SADDR will be compared with the incoming serial data. When SADEN.n is 0, then the bit becomes a "don't care" in the comparison. This register enables the Automatic Address Recognition feature of the Serial port 0. When all the bits of SADEN are 0, interrupt will occur for any incoming address.

Power Management Register

Bit:	7	6	5	4	3	2	1	0
	-	-	-	-	-	ALE-OFF	-	DME0

Mnemonic: PMR Address: C4h

ALE0FF: This bit disables the expression of the ALE signal on the device pin during all on-board program and data memory accesses. External memory accesses will automatically enable ALE independent of ALEOFF.

0 = ALE expression is enable; 1 = ALE expression is disable

DME0: This bit determines the on-chip MOVX SRAM to be enabled or disabled. Set this bit to 1 will enable the on-chip 1KB MOVX SRAM.

Timer 2 LSB

Bit:	7	6	5	4	3	2	1	0
	TL2.7	TL2.6	TL2.5	TL2.4	TL2.3	TL2.2	TL2.1	TL2.0

Mnemonic: TL2 Address: CCh

TL2: Timer 2 LSB

Timer 2 MSB

Bit:	7	6	5	4	3	2	1	0
	TH2.7	TH2.6	TH2.5	TH2.4	TH2.3	TH2.2	TH2.1	TH2.0

Mnemonic: TH2 Address: CDh

TH2: Timer 2 MSB

Program Status Word

Bit:	7	6	5	4	3	2	1	0
	CY	AC	F0	RS1	RS0	OV	F1	P

Mnemonic: PSW Address: D0h

CY: Carry flag: Set for an arithmetic operation which results in a carry being generated from the ALU. It is also used as the accumulator for the bit operations.

AC: Auxiliary carry: Set when the previous operation resulted in a carry from the high order nibble.

F0: User flag 0: General purpose flag that can be set or cleared by the user.

RS.1-0: Register bank select bits:

RS1	RS0	Register bank	Address
0	0	0	00-07h
0	1	1	08-0Fh
1	0	2	10-17h
1	1	3	18-1Fh

OV: Overflow flag: Set when a carry was generated from the seventh bit but not from the 8th bit as a result of the previous operation, or vice-versa.

F1: User Flag 1: General purpose flag that can be set or cleared by the user by software.

P: Parity flag: Set/cleared by hardware to indicate odd/even number of 1's in the accumulator.

Watchdog Control

Bit:	7	6	5	4	3	2	1	0
	-	POR	-	-	WDIF	WTRF	EWT	RWT

Mnemonic: WDCON Address: D8h

POR: Power-on reset flag. Hardware will set this flag on a power up condition. This flag can be read or written by software. A write by software is the only way to clear this bit once it is set.

WDIF: Watchdog Timer Interrupt Flag. If the watchdog interrupt is enabled, hardware will set this bit to indicate that the watchdog interrupt has occurred. If the interrupt is not enabled, then this bit indicates that the time-out period has elapsed. This bit must be cleared by software.

Reset State

Most of the SFRs and registers on the device will go to the same condition in the reset state. The Program Counter is forced to 0000h and is held there as long as the reset condition is applied. However, the reset state does not affect the on-chip RAM. The data in the RAM will be preserved during the reset. However, the stack pointer is reset to 07h, and therefore the stack contents will be lost. The RAM contents will be lost if the V_{DD} falls below approximately 2V, as this is the minimum voltage level required for the RAM to operate normally. Therefore after a first time power on reset the RAM contents will be indeterminate. During a power fail condition, if the power falls below 2V, the RAM contents are lost.

After a reset most SFRs are cleared. Interrupts and Timers are disabled. The Watchdog timer is disabled if the reset source was a POR. The port SFRs have FFh written into them which puts the port pins in a high state. Port 0 floats as it does not have on-chip pull-ups.

Table 6. SFR Reset Value

SFR NAME	RESET VALUE	SFR NAME	RESET VALUE
P0	11111111b	IE	00000000b
SP	00000111b	SADDR	00000000b
DPL	00000000b	P3	11111111b
DPH	00000000b	IP	x0000000b
PMR	010xx0x0b	SADEN	00000000b
STATUS	000x0000b	T2CON	00000000b
PC	00000000b	T2MOD	00000x00b
PCON	00xx0000b	RCAP2L	00000000b
TCON	00000000b	RCAP2H	00000000b
TMOD	00000000b	TL2	00000000b
TL0	00000000b	TH2	00000000b
TL1	00000000b	TA	11111111b
TH0	00000000b	PSW	00000000b
TH1	00000000b	WDCON	0x0x0xx0b
CKCON	00000001b	ACC	00000000b
P1	11111111b	EIE	xxx00000b
P4CONA	00000000b	P4CONB	00000000b
P40AL	00000000b	P40AH	00000000b
P41AL	00000000b	P41AH	00000000b
P42AL	00000000b	P42AH	00000000b
P43Al	00000000b	P43AH	00000000b
CHPCON	00000000b	P4CSIN	00000000b
ROMCON	00000111b	SFRAL	00000000b
SFRAH	00000000b	SFRFD	00000000b

Priority Level Structure

There are three priority levels for the interrupts, highest, high and low. The interrupt sources can be individually set to either high or low levels. Naturally, a higher priority interrupt cannot be interrupted by a lower priority interrupt. However there exists a pre-defined hierarchy amongst the interrupts themselves. This hierarchy comes into play when the interrupt controller has to resolve simultaneous requests having the same priority level. This hierarchy is defined as shown below; the interrupts are numbered starting from the highest priority to the lowest.

Table 7. Priority structure of interrupts

SOURCE	FLAG	VECTOR ADDRESS	PRIORITY LEVEL
External Interrupt 0	IE0	0003h	1(highest)
Timer 0 Overflow	TF0	000Bh	2
External Interrupt 1	IE1	0013h	3
Timer 1 Overflow	TF1	001Bh	4
Serial Port	RI + TI	0023h	5
Timer 2 Overflow	TF2 + EXF2	002Bh	6
Watchdog Timer	WDIF	0063h	7 (lowest)

time-base may be either clock cycles/12 or clock cycles/4 as selected by the bits TxM of the CKCON SFR.

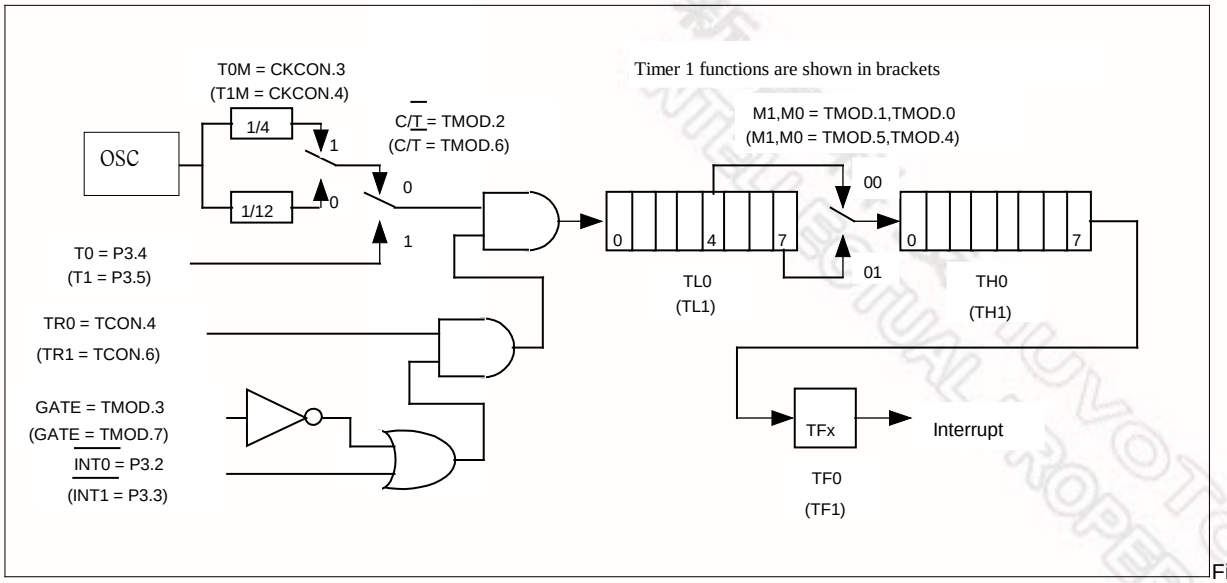


Figure 11. Timer/Counter Mode 0 & Mode 1

Mode 1

Mode 1 is similar to Mode 0 except that the counting register forms a 16 bit counter, rather than a 13 bit counter. This means that all the bits of THx and TLx are used. Roll-over occurs when the timer moves from a count of FFFFh to 0000h. The timer overflow flag TFx of the relevant timer is set and if enabled an interrupt will occur. The selection of the time-base in the timer mode is similar to that in Mode 0. The gate function operates similarly to that in Mode 0.

Mode 2

In Mode 2, the timer/counter is in the Auto Reload Mode. In this mode, TLx acts as a 8 bit count register, while THx holds the reload value. When the TLx register overflows from FFh to 00h, the TFx bit in TCON is set and TLx is reloaded with the contents of THx, and the counting process continues from here. The reload operation leaves the contents of the THx register unchanged. Counting is enabled by the TRx bit and proper setting of GATE and $\overline{\text{INTx}}$ pins. As in the other two modes 0 and 1 mode 2 allows counting of either clock cycles (clock/12 or clock/4) or pulses on pin Tn.

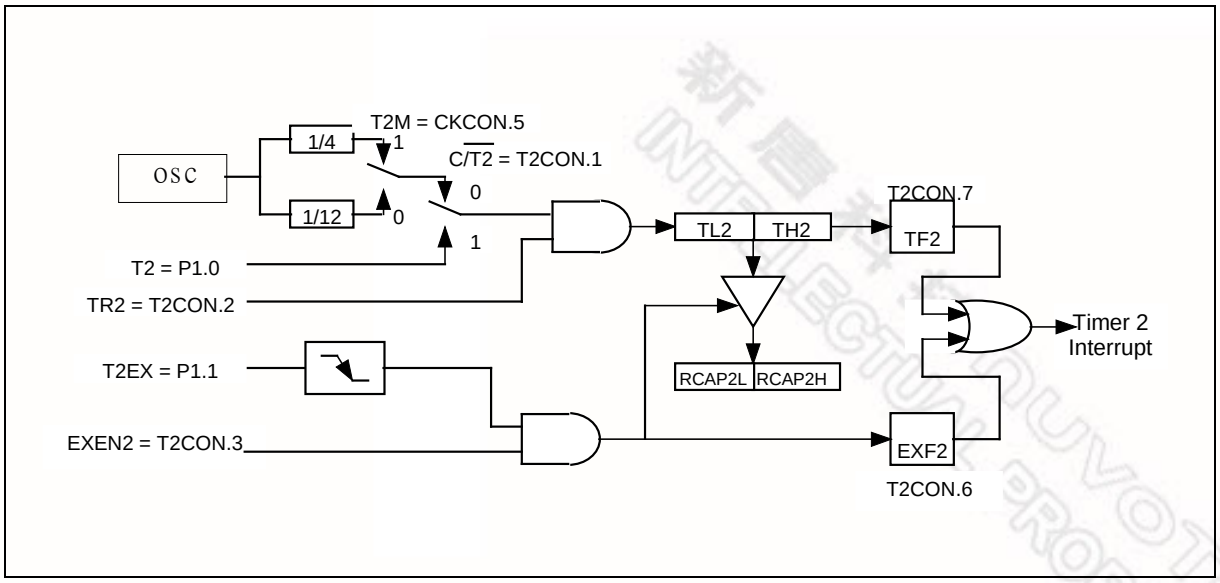


Figure 14. 16-Bit Capture Mode

Auto-reload Mode, Counting up

The auto-reload mode as an up counter is enabled by clearing the CP / $\overline{RL2}$ bit in the T2CON register and clearing the DCEN bit in T2MOD register. In this mode, Timer/Counter 2 is a 16 bit up counter. When the counter rolls over from FFFFh, a reload is generated that causes the contents of the RCAP2L and RCAP2H registers to be reloaded into the TL2 and TH2 registers. The reload action also sets the TF2 bit. If the EXEN2 bit is set, then a negative transition of T2EX pin will also cause a reload. This action also sets the EXF2 bit in T2CON.

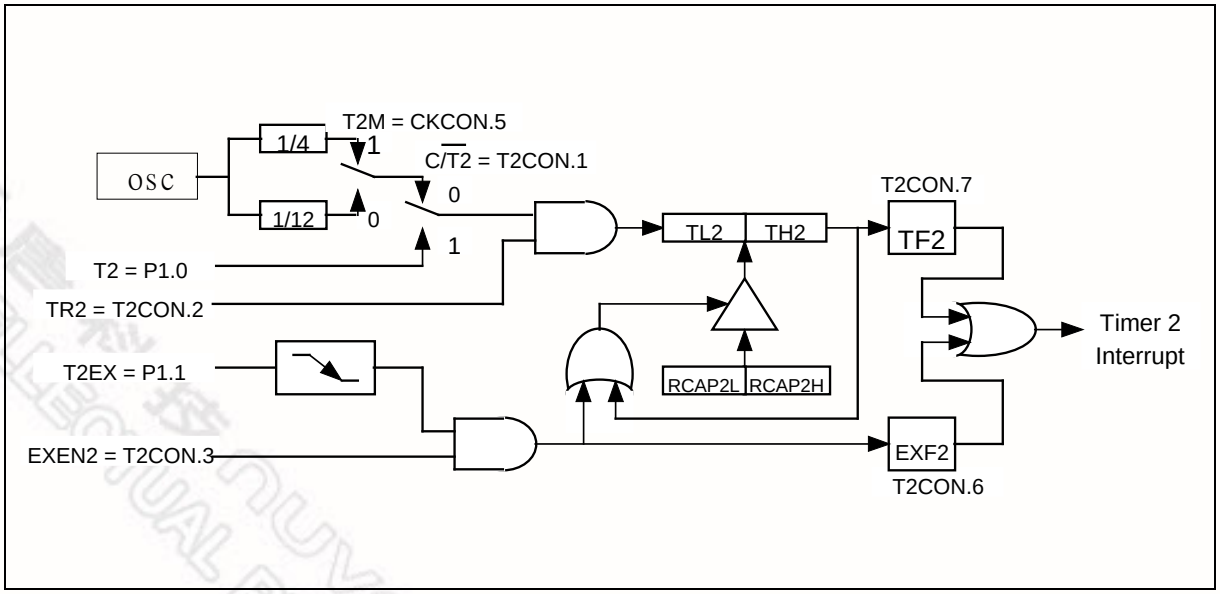


Figure 15. 16-Bit Auto-reload Mode, Counting Up

Auto-reload Mode, Counting Up/Down

Timer/Counter 2 will be in auto-reload mode as an up/down counter if CP / $\overline{RL2}$ bit in T2CON is cleared and the DCEN bit in T2MOD is set. In this mode, Timer/Counter 2 is an up/down counter whose direction is controlled by the T2EX pin. A 1 on this pin cause the counter to count up. An overflow while counting up will cause the counter to be reloaded with the contents of the capture registers. The next down count following the case where the contents of Timer/Counter equal the capture registers will load an FFFFh into Timer/Counter 2. In either event a reload will set the TF2 bit. A reload will also toggle the EXF2 bit. However, the EXF2 bit can not generate an interrupt while in this mode.

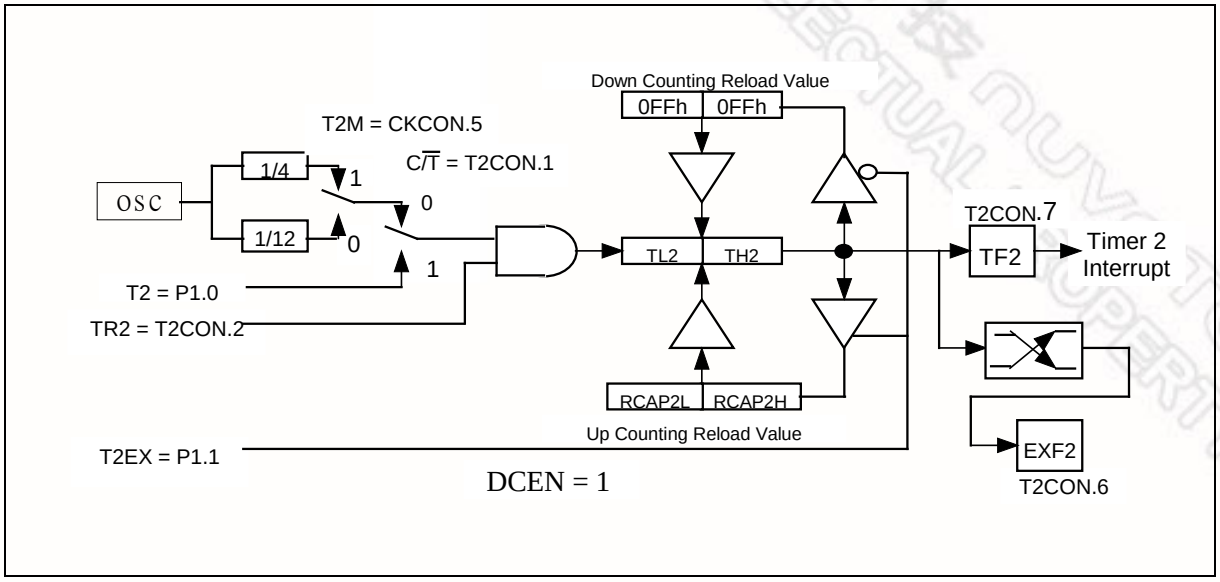


Figure 16. 16-Bit Auto-reload Up/Down Counter

The Watchdog timer should first be restarted by using RWT. This ensures that the timer starts from a known state. The RWT bit is used to restart the watchdog timer. This bit is self clearing, i.e. after writing a 1 to this bit the software will automatically clear it. The watchdog timer will now count clock cycles. The time-out interval is selected by the two bits WD1 and WD0 (CKCON.7 and CKCON.6). When the selected time-out occurs, the Watchdog interrupt flag WDIF (WDCON.3) is set. After the time-out has occurred, the watchdog timer waits for an additional 512 clock cycles. If the Watchdog Reset EWT (WDCON.1) is enabled, then 512 clocks after the time-out, if there is no RWT, a system reset due to Watchdog timer will occur. This will last for two machine cycles, and the Watchdog timer reset flag WTRF (WDCON.2) will be set. This indicates to the software that the watchdog was the cause of the reset.

When used as a simple timer, the reset and interrupt functions are disabled. The timer will set the WDIF flag each time the timer completes the selected time interval. The WDIF flag is polled to detect a time-out and the RWT allows software to restart the timer. The Watchdog timer can also be used as a very long timer. The interrupt feature is enabled in this case. Every time the time-out occurs an interrupt will occur if the global interrupt enable EA is set.

The main use of the Watchdog timer is as a system monitor. This is important in real-time control applications. In case of some power glitches or electro-magnetic interference, the processor may begin to execute errant code. If this is left unchecked the entire system may crash. Using the watchdog timer interrupt during software development will allow the user to select ideal watchdog reset locations. The code is first written without the watchdog interrupt or reset. Then the watchdog interrupt is enabled to identify code locations where interrupt occurs. The user can now insert instructions to reset the watchdog timer which will allow the code to run without any watchdog timer interrupts. Now the watchdog timer reset is enabled and the watchdog interrupt may be disabled. If any errant code is executed now, then the reset watchdog timer instructions will not be executed at the required instants and watchdog reset will occur.

The watchdog time-out selection will result in different time-out values depending on the clock speed. The reset, when enabled, will occur 512 clocks after the time-out has occurred.

Table 9. Time-out values for the Watchdog timer

WD1	WD0	WATCHDOG INTERVAL	NUMBER OF CLOCKS	Time @ 1.8432 MHz	Time @ 10 MHz	Time @ 25 MHz
0	0	2^{17}	131072	71.11 mS	13.11 mS	5.24 mS
0	1	2^{20}	1048576	568.89 mS	104.86 mS	41.94 mS
1	0	2^{23}	8388608	4551.11 mS	838.86 mS	335.54 mS
1	1	2^{26}	67108864	36408.88 mS	6710.89 mS	2684.35 mS

The Watchdog timer will de disabled by a power-on/fail reset. The Watchdog timer reset does not disable the watchdog timer, but will restart it. In general, software should restart the timer to put it into a known state.

The control bits that support the Watchdog timer are discussed below.

1. RI must be 0 and
2. Either SM2 = 0, or the received stop bit = 1.

If these conditions are met, then the stop bit goes to RB8, the 8 data bits go into SBUF and RI is set. Otherwise the received frame may be lost. After the middle of the stop bit, the receiver goes back to looking for a 1-to-0 transition on the RxD pin.

Mode 3

This mode is similar to Mode 2 in all respects, except that the baud rate is programmable. The user must first initialize the Serial related SFR SCON before any communication can take place. This involves selection of the Mode and baud rate. The Timer 1 should also be initialized if modes 1 and 3 are used. In all four modes, transmission is started by any instruction that uses SBUF as a destination register. Reception is initiated in Mode 0 by the condition RI = 0 and REN = 1. This will generate a clock on the TxD pin and shift in 8 bits on the RxD pin. Reception is initiated in the other modes by the incoming start bit if REN = 1. The external device will start the communication by transmitting the start bit.

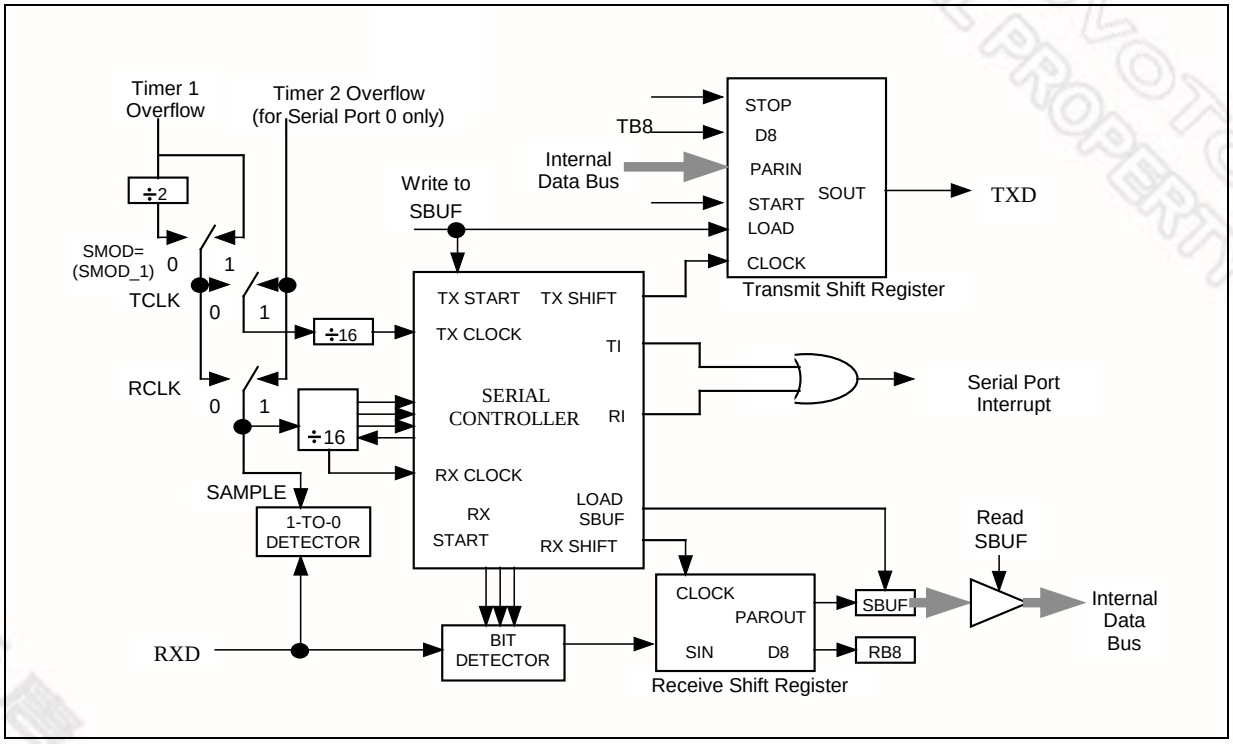


Figure 23. Serial Port Mode 3

Table 10. Serial Ports Modes

SM1	SM0	MODE	TYPE	BAUD CLOCK	FRAME SIZE	START BIT	STOP BIT	9TH BIT FUNCTION
0	0	0	Synch.	4 or 12 TCLKS	8 bits	No	No	None
0	1	1	Asynch.	Timer 1 or 2	10 bits	1	1	None
1	0	2	Asynch.	32 or 64 TCLKS	11 bits	1	1	0, 1
1	1	3	Asynch.	Timer 1 or 2	11 bits	1	1	0, 1

DC Characteristics, continued

PARAMETER	SYM.	SPECIFICATION			TEST CONDITIONS
		MIN.	MAX.	UNIT	
Input High Voltage P0, P1, P2, P3, $\overline{EA}$	V_{IH1}	2.4	V_{DD} +0.2	V	V_{DD} = 5.5V
		1.8	V_{DD} +0.2	V	V_{DD} = 3.3V
Input High Voltage RST	V_{IH2}	3.5	V_{DD} +0.2	V	V_{DD} = 5.5V
		2.0	V_{DD} +0.2	V	V_{DD} = 3.3V
Input High Voltage XTAL1[*3]	V_{IH3}	3.5	V_{DD} +0.2	V	V_{DD} = 5.5V
		2.0	V_{DD} +0.2	V	V_{DD} = 3.3V
Sink current P1, P3	Isk1	4	8	mA	V_{DD} = 4.5V, V_{OL} = 0.45
		3.2	7	mA	V_{DD} = 3.3V, V_{OL} = 0.4
Sink current P0,P2, ALE, $\overline{PSEN}$	Isk2	10	14	mA	V_{DD} = 4.5V , V_{OL} = 0.45V
		6.5	9.5	mA	V_{DD} = 3.3V, V_{OL}=0.4
Source current P1, P2 (I/O), P3	Isr1	-180	-330	uA	V_{DD} = 4.5V, V_{OL} = 2.4V
		-100	-220	uA	V_{DD} = 3.3V, V_{OL} = 1.4V
Source current P0,P2 (address), ALE, $\overline{PSEN}$	Isr2	-10	-14	mA	V_{DD} = 4.5V, V_{OL} = 2.4V
		-6	-9	mA	V_{DD} = 3.3V, V_{OL} = 1.4V
Output Low Voltage P1, P2 (I/O), P3	V_{OL1}	-	0.45	V	V_{DD} = 4.5V, I_{OL} = +6 mA
		-	0.4	V	V_{DD} = 3.3V, I_{OL} = +3.8 mA
Output Low Voltage P0, P2(address), ALE, $\overline{PSEN}$ [*2]	V_{OL2}	-	0.45	V	V_{DD} = 4.5V, I_{OL} = +10 mA
		-	0.4	V	V_{DD} = 3.3V, I_{OL} = +6.5 mA
Output High Voltage P1, P3	V_{OH1}	2.4	-	V	V_{DD} = 4.5V, I_{OH} = -180μA
		1.4	-	V	V_{DD} = 3.3V, I_{OL} = -100 uA
Output High Voltage P0, P2, ALE, $\overline{PSEN}$ [*2]	V_{OH2}	2.4	-	V	V_{DD} = 4.5V, I_{OH} = -10mA
		1.4	-	V	V_{DD} = 3.3V, I_{OL} = -6 mA

Notes:

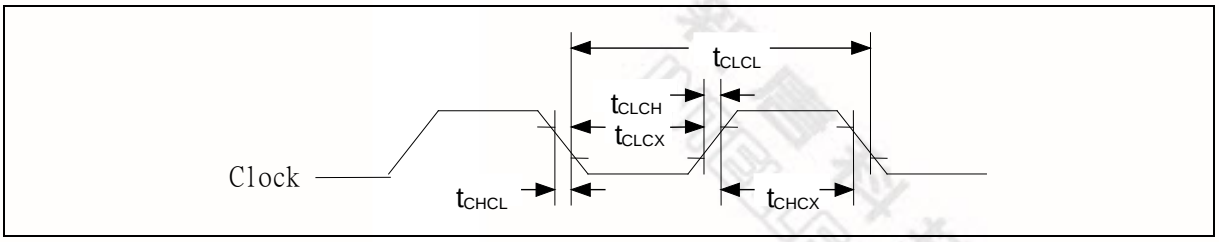
*1. RST pin is a Schmitt trigger input.

*2. P0, ALE and $\overline{PSEN}$ are tested in the external access mode.

*3. XTAL1 is a CMOS input.

*4. Pins of P1, P2, P3 can source a transition current when they are being externally driven from 1 to 0. The transition current reaches its maximum value when VIN approximates to 2V.

17.3 A.C. Characteristics



Note: Duty cycle is 50%.

External Clock Characteristics

(T_A = 25°C, V_{DD} =5.0V.)

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNITS	NOTES
Clock High Time	t_{CHCX}	12	-	-	nS	
Clock Low Time	t_{CLCX}	12	-	-	nS	
Clock Rise Time	t_{CLCH}	-	-	10	nS	
Clock Fall Time	t_{CHCL}	-	-	10	nS	

17.3.1 A.C. Specification

(T_A = 25°C, V_{DD} =5.0V.)

PARAMETER	SYMBOL	VARIABLE CLOCK MIN.	VARIABLE CLOCK MAX.	UNITS
Oscillator Frequency	$1/t_{CLCL}$	0	40	MHz
ALE Pulse Width	t_{LHLL}	$1.5t_{CLCL}$ - 5		nS
Address Valid to ALE Low	t_{AVLL}	$0.5t_{CLCL}$ - 5		nS
Address Hold After ALE Low	t_{LLAX1}	$0.5t_{CLCL}$ - 5		nS
Address Hold After ALE Low for MOVX Write	t_{LLAX2}	$0.5t_{CLCL}$ - 5		nS
ALE Low to Valid Instruction In	t_{LLIV}		$2.5t_{CLCL}$ - 20	nS
ALE Low to PSEN Low	t_{LLPL}	$0.5t_{CLCL}$ - 5		nS
$\overline{PSEN}$ Pulse Width	t_{PLPH}	$2.0t_{CLCL}$ - 5		nS
$\overline{PSEN}$ Low to Valid Instruction In	t_{PLIV}		$2.0t_{CLCL}$ - 20	nS
Input Instruction Hold After PSEN	t_{PXIX}	0		nS
Input Instruction Float After PSEN	t_{PXIZ}		t_{CLCL} - 5	nS
Port 0 Address to Valid Instr. In	t_{AVIV1}		$3.0t_{CLCL}$ - 20	nS
Port 2 Address to Valid Instr. In	t_{AVIV2}		$3.5t_{CLCL}$ - 20	nS
$\overline{PSEN}$ Low to Address Float	t_{PLAZ}	0		nS
Data Hold After Read	t_{RHDX}	0		nS
Data Float After Read	t_{RHDZ}		t_{CLCL} - 5	nS
$\overline{RD}$ Low to Address Float	t_{RLAZ}		$0.5t_{CLCL}$ - 5	nS

17.3.2 Operating Frequency vs Voltage

DEVICE	OPERATING FREQUENCY	OPERATING VOLTAGE
W79E632A40PL	Up to 40.0MHz	5.0V ~ 5.5V
	Up to 36.8MHz	4.5V ~ 5.5V
W79L632A25PL	Up to 20.0MHz	3.3V ~ 5.5V
	Up to 12.0MHz	3.0V ~ 5.5V

17.3.3 MOVX Characteristics Using Strech Memory Cycle

PARAMETER	SYMBOL	VARIABLE CLOCK MIN.	VARIABLE CLOCK MAX.	UNITS	STRECH
Data Access ALE Pulse Width	t_{LLHL2}	$1.5t_{CLCL}$ - 5 $2.0t_{CLCL}$ - 5		nS	t_{MCS} = 0 t_{MCS}>0
Address Hold After ALE Low for MOVX write	t_{LLAX2}	$0.5t_{CLCL}$ - 5		nS	
$\overline{RD}$ Pulse Width	t_{RLRH}	$2.0t_{CLCL}$ - 5 t_{MCS} - 10		nS	t_{MCS} = 0 t_{MCS}>0
$\overline{WR}$ Pulse Width	t_{WLWH}	$2.0t_{CLCL}$ - 5 t_{MCS} - 10		nS	t_{MCS} = 0 t_{MCS}>0
$\overline{RD}$ Low to Valid Data In	t_{RLDV}		$2.0t_{CLCL}$ - 20 t_{MCS} - 20	nS	t_{MCS} = 0 t_{MCS}>0
Data Hold after Read	t_{RHDX}	0		nS	
Data Float after Read	t_{RHDZ}		t_{CLCL} - 5 $2.0t_{CLCL}$ - 5	nS	t_{MCS} = 0 t_{MCS}>0
ALE Low to Valid Data In	t_{LLDV}		$2.5t_{CLCL}$ - 5 t_{MCS} + $2t_{CLCL}$ - 40	nS	t_{MCS} = 0 t_{MCS}>0
Port 0 Address to Valid Data In	t_{AVDV1}		$3.0t_{CLCL}$ - 20 $2.0t_{CLCL}$ - 5	nS	t_{MCS} = 0 t_{MCS}>0
ALE Low to $\overline{RD}$ or $\overline{WR}$ Low	t_{LLWL}	$0.5t_{CLCL}$ - 5 $1.5t_{CLCL}$ - 5	$0.5t_{CLCL}$ + 5 $1.5t_{CLCL}$ + 5	nS	t_{MCS} = 0 t_{MCS}>0
Port 0 Address to $\overline{RD}$ or $\overline{WR}$ Low	t_{AVWL}	t_{CLCL} - 5 $2.0t_{CLCL}$ - 5		nS	t_{MCS} = 0 t_{MCS}>0
Port 2 Address to $\overline{RD}$ or $\overline{WR}$ Low	t_{AVWL2}	$1.5t_{CLCL}$ - 5 $2.5t_{CLCL}$ - 5		nS	t_{MCS} = 0 t_{MCS}>0
Data Valid to WR Transition	t_{QVWX}	-5 $1.0t_{CLCL}$ - 5		nS	t_{MCS} = 0 t_{MCS}>0
Data Hold after Write	t_{WHQX}	t_{CLCL} - 5		nS	t_{MCS} = 0

18. TYPICAL APPLICATION CIRCUITS

Expanded External Program Memory and Crystal

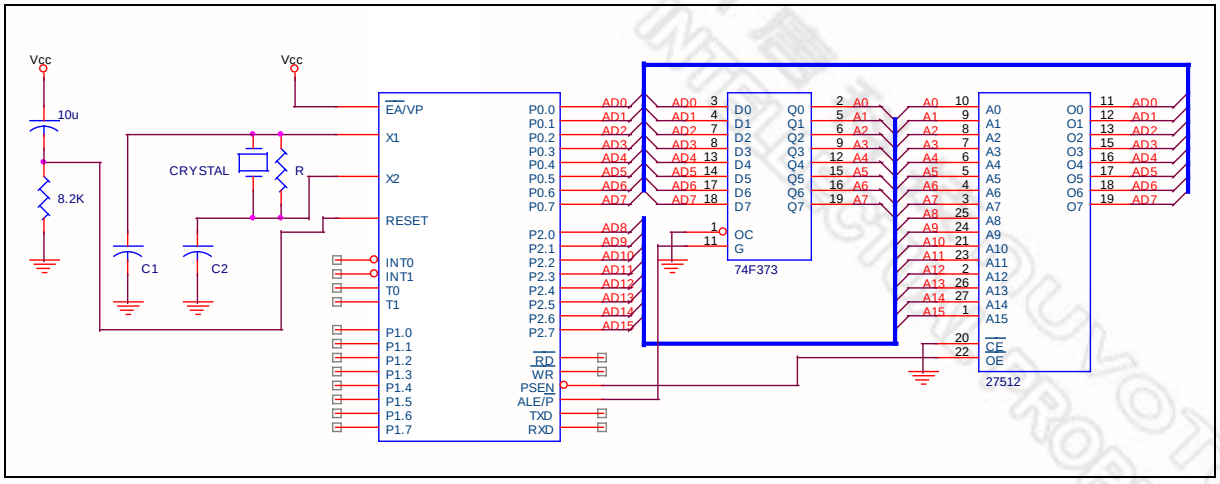


Figure A

CRYSTAL	C1	C2	R
16 MHz	20P	20P	-
24 MHz	12P	12P	-
33 MHz	10P	10P	3.3K
40 MHz	1P	1P	3.3K

The above table shows the reference values for crystal applications.

Note: C1, C2, R components refer to Figure A.

Expanded External Data Memory and Oscillator

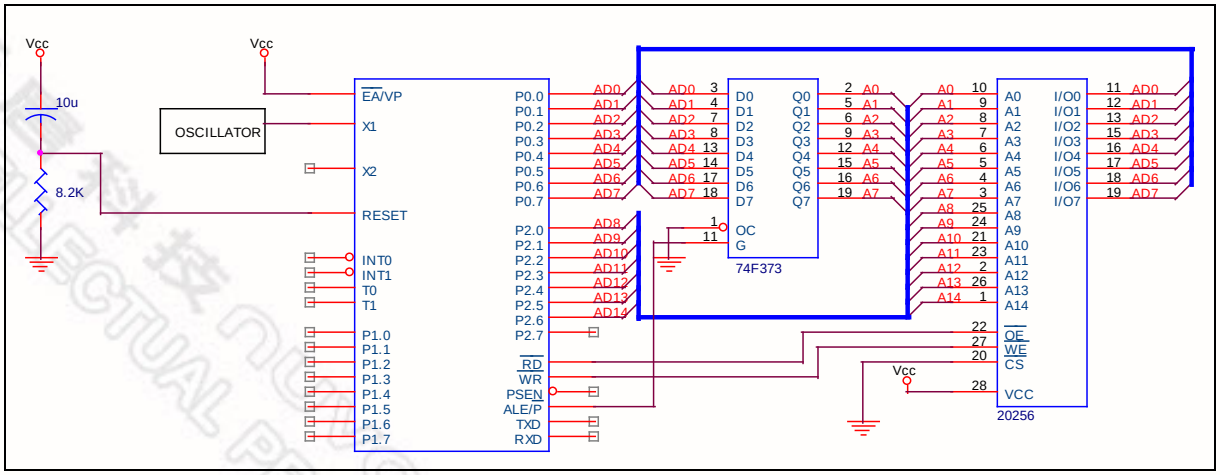


Figure B

```
        INC  DPTR
        CJNE  A,SFRFD,ERROR_64K
        CJNE  R2,#0H,READ_VERIFY_64K
        INC  R1
        MOV  SFRAH,R1
        CJNE  R1,#0H,READ_VERIFY_64K

;*****************************************************************************
;* PROGRAMMING COMPLETLY, SOFTWARE RESET CPU
;*****************************************************************************
        MOV  TA,#AAH
        MOV  TA,#55H
        MOV  CHPCON,#83H      ; SOFTWARE RESET. CPU will restart from APFlash0

ERROR_64K:
        DJNZ  R4,UPDATE_64K   ; IF ERROR OCCURS, REPEAT 3 TIMES.
.                             ; IN-SYST PROGRAMMING FAIL, USER'S PROCESS TO DEAL WITH IT.
                              .
                              .
                              .
```

21. REVISION HISTORY

VERSION	DATE	PAGE	DESCRIPTION
A1	July 8, 2003	-	Initial Issued
A2	Apr 28, 2005	2	Add Lead Free package.
A3	Aug 16, 2005	2, 4, 10 59	Add Port 0 pull-up resisters information Remove encrypt function of Security bits B2 description
A4	November 6, 2006	-	Add wide voltage device (W79L632)
		3	Add device list.
		61-62	Modify DC characteristic.
		2	Remove all Leaded package parts.
		3, 64	Revise Operating speed to 20MHz on W79L632A25PL.
A5	January 03, 2007	2, 3	Add QFP44 and DIP40 package parts.
		66, 67	Add test condition in AC specification.
A6	February 1, 2007	11	Revise the Timer Mode Setting to “Mode 1: 16-bits, no pre-scale”.
A7	January 6, 2009	2	1. Add a note for V_{DD} during power on/off.
A8	February 11, 2009	3 67	1. Modify the operating frequency vs voltage 2. Add 17.3.2 Operating Frequency vs Voltage
A9	August 18, 2009	73	Add the QFP 44PIN package dimension
A10	Nov. 11, 2009	3	Remove the DIP40 package

Important Notice

Nuvoton Products are neither intended nor warranted for usage in systems or equipment, any malfunction or failure of which may cause loss of human life, bodily injury or severe property damage. Such applications are deemed, “Insecure Usage”.

Insecure usage includes, but is not limited to: equipment for surgical implementation, atomic energy control instruments, airplane or spaceship instruments, the control or operation of dynamic, brake or safety systems designed for vehicular use, traffic signal instruments, all types of safety devices, and other applications intended to support or sustain life.

All Insecure Usage shall be made at customer’s risk, and in the event that third parties lay claims to Nuvoton as a result of customer’s Insecure Usage, customer shall indemnify the damages and liabilities thus incurred by Nuvoton.